

LIQUID CRYSTAL DISPLAY MODULE

Product Specification

DENSITRON	STANDARD LCD MO	DULE
PRODUCT NUMBER	LMR/TSR 3234 – LMR/TSR 4234 – LMR/TSR 6234	
DEFINITION	Display 240*128 dots	Date 19/04/04

	INTERNAL APPROVALS				
Quality Mgr	y Mgr Product Mgr Project Leader Mech. Eng Electr. Eng				
Date:	Date:	Date:	Date:	Date:	



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REVISION RECORD

Rev.	Date	Page	Chapt.	Comment	ECR no.
1	19/04/04			Initial Specification	
2	08/08/2008	43	7	Add High Brightness LED option.	



1 PART NUMBER DESCRIPTION FOR AVAILABLE OPTIONS

LMR 0234 203- 466 7

① BACKLIGHT TYPE

3 = Module without Backlight or with EL Backlight

4 = Module with LED Backlight

6 = Module with CCFL Backlight

2 POLARIZER TYPE

B = Transflective: light background E = Transmissive: dark background

3 BACKLIGHT COLOR

G = Yellow-Green (Standard)

W = White LED

None if CCFL Backlight

4 FLUID TYPE AND POWER SUPPLY

D = Standard temperature range with external negative voltage operation

S = Standard temperature range with on-board negative voltage generation

H = Wide temperature range with external negative voltage operation

W = Wide temperature range with on-board negative voltage generator

S TEMPERATURE COMPENSATION CIRCUIT

N = Without on board temperature compensation circuit

C = With on board temperature compensation circuit

© COLOR FOR STN FLUID

B = STN Blue background (available for E polarizer type only)

G = STN Blue Pixels on Gray background for B polarizer types only

Y = STN Blue Pixels on Yellow background for B polarizer types only

F = FSTN Black Pixels or background depending on B or E polarizer type

(2) ADDITIONNAL OPTIONS

12 = it is mentioned if top view angle is needed

HL = High Luminosity for White LED Backlight if avaible

"LMR" AT THE BEGINNING OF THE PART NUMBER IS REPLACED BY "TSR" IF THE MODULE HAS A TOUCH PANNEL

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2 MAIN FEATURES

ITEM	CONTENTS
Display Format	240 * 128 dos
Overall Dimensions	144.0×104.0×14.3(MAX)mm
Viewing Area	114.0×64.0mm
LCD type	STN / FSTN
Mode	Available in Reflective / Transflective / Transmissive
Viewing Angle	6 and 12 o'clock
Duty ratio	1/128
Driver IC	T6963C
Backlight type	None / LED / CCFL
Backlight colour	Yellow Green / White / Amber
DC/DC converter	None or Included
Operating temperature	From 0/+50°C to -20°/+70°C
Storage temperature	From -20°/+70°C to -30°/+80°C



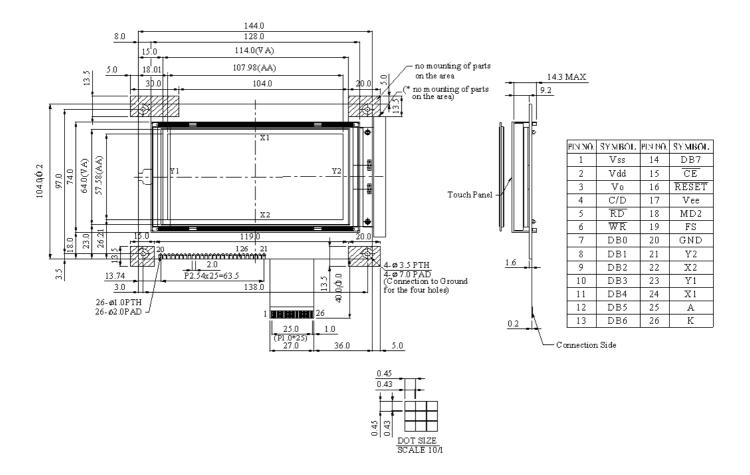
3 MECHANICAL SPECIFICATION

3.1 MECHANICAL CHARACTERISTICS

ITEM	CHARACTERISTIC	UNIT
Display Format	240 * 128 dots	
Overall Dimensions	144.0×104.0×14.3(MAX)	mm
Viewing Area	114.0×64.0	mm
Active Area	107.98×57.58	mm
Dot Size	(L)0.43×(W)0.43	mm
Dot Pitch	(L)0.45×(W)0.45	mm
IC Controller/Driver	T6963C	·



3.2 MECHANICAL DRAWING



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4 ELECTRICAL SPECIFICATION

4.1 ABSOLUTE MAXIMUM RATINGS

VSS = 0 V, Ta = 25 °C

Item	Symbol	Min	Тур	Max	Unit	Note
Power Supply Voltage	$ m V_{DD} ext{-}V_{SS}$	-0,3	-	+7,0	V	
Power Supply for LCD	$ m V_{DD} ext{-}V_0$	0	-	21	V	
Input Voltage	Vin	V_{SS}	-	V_{DD}	V	
Operating Temperature	Тор	0 -20	-	+50 +70	°C	Note 1
Storage Temperature	Tst	-20 -30	-	+70 +80	°C	Note 2
Static Electricity	Be sure that you are grounded when handling displays.			•		

Note 1: Background colour changes slightly depending on ambient temperature. This phenomenon is reversible. Ta≤70 °C: 75% RH max

Note 2: Ta≤80 °C: 75% RH max

4.2 ELECTRICAL CHARACTERISTICS

VSS = 0 V, Ta = 25 °C

Item	Symbol	Condition	Min	Тур	Max	Unit
Power Supply for Logic	V_{DD} - V_{SS}	Ta = 25 °C	4,75	5,0	5,25	V
I	V_{IL}	Ta = 25 °C	0	-	0,8	V
Input Voltage	V_{IH}	Ta = 25 °C	2,2	-	V_{DD}	V
Output Voltage	V_{OL}	Ta = 25 °C	0	-	0,4	V
Output voltage	V _{OH}	Ta = 25 °C	2,4	-	V_{DD}	V
		Ta = -20 °C	-	-	21	V
LCD Module Driving Voltage	V _{DD} -V _O	Ta = 25 °C	-	19,1	-	V
		Ta = 70 °C	17	-	-	V
Current Consumption	* I _{DD}	$V_{DD} = 5V$ $V_{LCD} = 19,1V$	-	34	-	mA

^{*} I_{DD} measurement condition is for all pattern ON



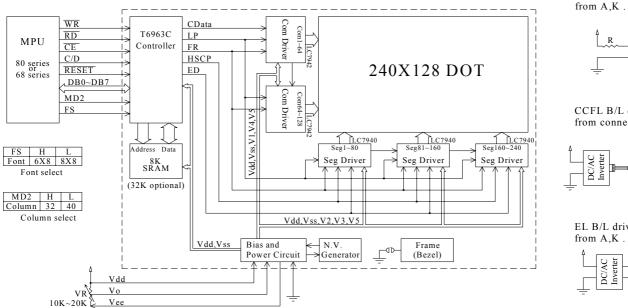
4.3 INTERFACE PIN ASSIGNMENT

No.	Symbol	I/O	Function
1	Vss		GND
2	Vdd		Power supply (+5 V)
3	Vo		Power supply for LCD driver
4	C/D	H/L	WR=L , C/D=H : Command Write C/D=L: Data write RD=L , C/D=H : Status Read C/D=L: Data read
5	/RD	L	Data read. Read data from T6963C when RD = L
6	/WR	L	Data write. Write data into T6963C when WR = L
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	/CE	L	L : Chip enable
16	/RESET	H/L	H: Normal; L: Initialize T6963C
17	Vee		Negative Voltage output (-16 V)
18	MD2	H/L	H: 32 columns ; L: 40 columns
19	FS	H/L	Pins for selection of font; H: 6 * 8, L: 8 * 8
20	GND		GND
21	Y2		
22	X2		
23	Y1		
24	X1		
25	A		
26	K		

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4.4 BLOCK DIAGRAM



External contrast adjustment.

	A B/L LCM
CCFL B/L d from connec	-
DC/AC Inverter	B/L LCM
EL B/L drive	e directly
DC/AC Inverter	A B/L LCM

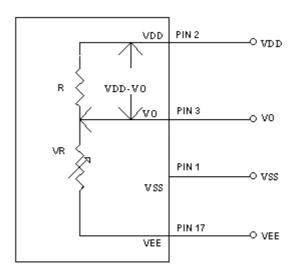
LED B/L drive directly

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Internal LCD VO Adjustment



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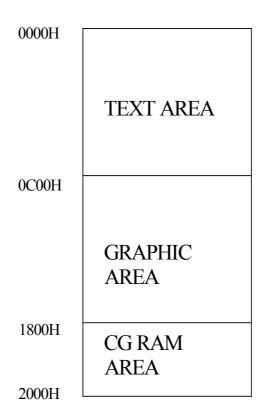
4.6 DISPLAY CONTROL INSTRUCTION

The LCD Module has built in a T6963C LSI controller, It has an 8-bit parallel data bus and control lines for writing or reading through an MPU interface, it has a 128-word character generator ROM (refer to Table 1.), which can control an external display RAM of up to 8K bytes. Allocation of text, graphics and external character generator RAM can be made easily and the display window can be moved freely within the allocated memory range.

•RAM Interface

The external RAM is used to store display data(text, graphic and external CG data). It can be freely allocated to the memory area (8 Kbyte max).

Recommend



□Flowchart of communications with MPU

(1)Status Read

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A status check must be performed before data is read or written.

Status check

The Status of T6963C can be read from the data lines.

 $\begin{array}{ccc} \overline{RD} & L \\ \overline{WR} & H \\ \overline{CE} & L \\ C/D & H \\ Do to D7 & H \end{array}$

The T6963C status word format is as follows:

MSB

						LSB	
STA7	STA6	STA5	STA4	STA3	STA2	STA1	STA0
D7	D6	D5	D4	D3	D2	D1	D0

STA0	Check command execution capability	0:Disable
21110	encon communication capacitation	1:Enable
STA1	Check data read/write Capability	0:Disable
51711	Check data read/write Capability	1:Enable
STA2	Check Auto mode data read capability	0:Disable
SIAZ	Check Auto mode data read capability	1:Enable
STA3 Check Auto mode data write capability		0:Disable
SIAS	Check Auto mode data write capability	1:Enable
STA4	Not used	
STA5	Charle controller energtion conshility	0:Disable
SIAS	Check controller operation capability	1:Enable
STA6	Error flag. Used for Screen Peek and Screen copy	0:No error
SIAU	commands.	1:Error
CTA 7	Ch 1- 4h - 1-1: - 1 1/4:	0:Disable off
STA7	Check the blink condition	1:Normal display

(Note 1) It is necessary to check STA0 and STA1 at the same time.

There is a possibility of erroneous operation due to a hardware interrupt.

(Note 2) For most modes STA0/STA1 are used as a status check.

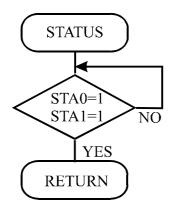
(Note 3) STA2 and STA3 are valid in Auto mode; STA0 and STA1 are invalid.

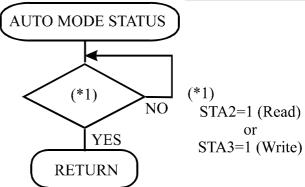
Status Checking flow

(a) (b)

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(Note 4) When using the MSB=0 command, a Status Read must be performed.

If a status check is not carried out, the T6963C cannot operate normally, even after a delay time.

The hardware interrupt occurs during the address calculation period (at the end of each line). If a MSB=0 command is sent to the T6963C during this period, the T6963C enters Wait status.

If a status check is not carried out in this state before the next command is sent, there is the possibility that the command or data date will not be received.

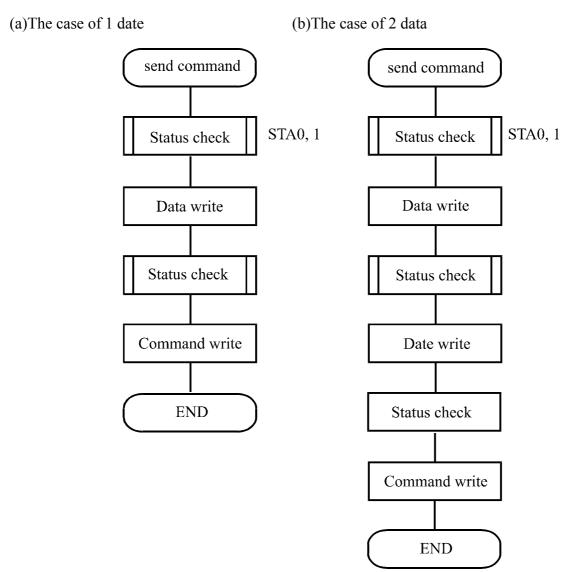
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(2)Setting date

When using the T6963C, first set the data, then set the command.

Procedure for sending a command



(Note) When sending more than two data, the last datum (or last two data)is valid.

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□ COMMAND DEFINITIONS

COMMAND	CODE	D1	D2	FUNCTION
REGISTERS SETTING	00100001 00100010	X address Date	Y address 00H	Set Cursor Pointer Set Offset Register
	00100100 01000000	Low address Low address	High address High address	Set Address Pointer Set Text Home Address
SET CONTROL WORD	01000001 01000010	Columns Low address	00H High address	Set Text Area Set Graphic Home Address
	01000010	Columns	00H	Set Graphic Area
	1000×000	-	-	
	1000×001	-	-	OR mode EXOR mode
MODERATE	1000×011	-	-	AND mode
MODE SET	1000×100	-	-	Text Attribute mode
	10000×××	-	-	Internal CG ROM mode External CG RAM mode
	10001×××	-	-	External Co Id IIV Mode
	10010000	-	-	Display off
	1001××10	-	-	Cursor on, blink off
DISPLAY MODE	10001××11	-	-	Cursor on, blink on
DIGI EAT WODE	100101××	-	-	Text on, graphic off
	100110××	-	-	Text off, graphic on Text on, graphic on
	100111××	-	-	Text on, grapine on
	10100000	-	-	1-line cursor
	10100001	-	-	2-line cursor
GUDGOD DUMMEDIA	10100010	-	-	3-line cursor
CURSOR PATTERN SELECT	10100011 10100100	-	-	4-line cursor 5-line cursor
SELECT	10100100	-	-	6-line cursor
	10100110	-	-	7-line cursor
	10100111	-	-	8-line cursor
DATA ALITO	10110000	-	-	Set Data Auto Write
DATA AUTO READ/WRITE	10110001	-	-	Set Data Auto Read
KE/IB/ WRITE	10110010	-	-	Auto Reset
DATA READ/WRITE	11000000	Data	-	Data Write and Increment ADP
	11000001	-	-	Data Read and Increment ADP
	11000010	Data	-	Data Write and Decrement ADP
	11000011	-	-	Data Read and Decrement ADP
	11000100 11000101	Data	-	Data Write and Non-variable ADP Data Read and Non-variable ADP
	11000101	-	-	Data Neau anu mon-variable ADP
SCREEN PEEK	11100000	-	-	Screen Peek
SCREEN COPY	11101000			Screen Copy

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	11110×××	-	-	
	11111×××	-	-	Bit Reset
	1111×000	-	_	Bit Set
	11111×001	_		Bit 0 (LSB)
		_		Bit 1
BIT SET/RESET	111111×010	-	-	Bit 2
DIT SET/RESET	11111×011	-	-	Bit 3
	11111×100	-	_	Bit 4
	11111×101	-		Bit 5
		-	_	Bit 6
	111111×110	-	-	Bit 7 (MSB)
	11111×111	-	-	

X: invalid

☐ Setting registers

CODE	HEX.	FUNCTION	D1	D2
00100001	21H	SET CURSOR POINTER	X ADRS	Y ADRS
00100010	23H	SET OFFSET REGISTER	DATA	00Н
00100100	24H	SET ADDRESS POINTER	LOW ADRS	HIGH ADRS

(1)Set Cursor Pointer

The position of the cursor is specified by X ADRS and Y ADRS. The cursor position can only be moved by this command. Data read/write from the MPU never changes the cursor pointer. X ADRS and Y ADRS are specified as follows.

X ADRS 00H to 4FH (lower 7 bits are valid)

Y ADRS 00H to 1FH (lower 5 bits are valid)

Single-Scan

X ADRS 00 to 4FH

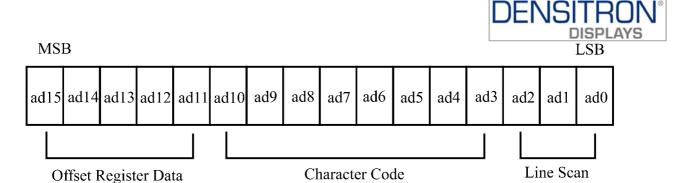
Y ADRS 00H to 0FH

(2)Set Offset Register

The offset register is used to determine the external character generator RAM area.

The T6963C has a 16-bit address bus as follows.

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T6963C assign External character generator, when character code set 80H TO FFH in using internal character generator. Character code 00H to 80H assign External character generator, when External generator mode.

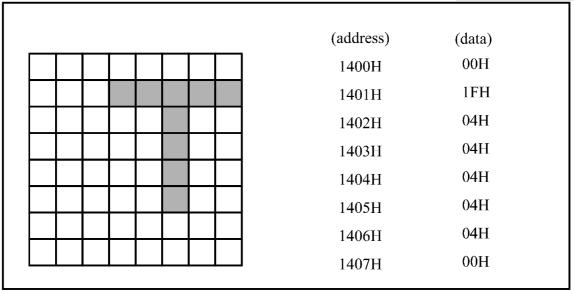
The senior five bits define the start address in external memory of the CG RAM area. The next eight bits represent the character code of the character. In internal CG ROM, character codes 00H to 7FH represent the predefined "internal" CG ROM characters, and codes 80H to FFH represent the user's own "external" characters. In external CG ROM mode, all 256 codes from 00H to FFH can be used to represent the user's own characters. The three least significant bits indicate one of the eight rows of eight dots that define the character's shape.

The relationship between display RAM address and offset register

Offset register data						CG RA	AM hex. address (start to end)
00000						0000 to	o 07 FFH
00001						0800 to	o 0FFFH
00010						1000 to	o 17FFH
11100						E000 to	o E7FFH
11101						E800 t	o EFFFH
11110						F000 to	o F7FFH
11111						F800 to	o FFFFH
(Example 1)							
Offset register						02H	
Character code							80H
Character generator RAI	M sta	rt ad	ldress	S			0001 0100 0000 0000
	1	4	0	0	Н		

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(Example 2) The relationship between display RAM data and display characters

	(RAM DATA)	(Character)
AB γ DE ζ GHIJKLM	21H	A
	22Н	В
	83H	γ
	24H	D
	25H	E
	86H	ζ
Display character		

 γ and ζ are displayed by character generator RAM.

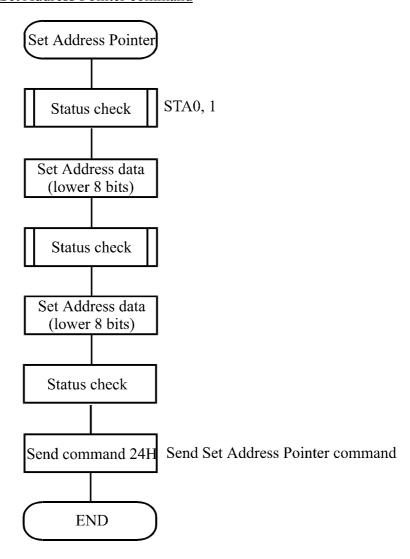
(3)Set Address Pointer

The Set Address Pointer command is used to indicate the start address for writing to (or reading from) external RAM.

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The Flowchart for Set Address Pointer command





☐ Set Control Word

CODE	HEX.	FUNCTION	D1	D2
01000000	40H	Set Text Home Address	Low address	High address
01000001	41H	Set Text Area	Columns	00H
01000010	42H	Set Graphic Home Address	Low address	High address
01000011	43H	Set Graphic Area	Columns	00H

The home address and column size are defined by this command.

(1)Set Text Home Address

The starting address in the external display RAM for text display is defined by this command.

The text home address indicates the leftmost and uppermost position.

The relationship between external display RAM address and display position

ТН	TH+CL
TH+TA	TH+TA+CL
(TH+TA)+TA	TH+2TA+CL
(TH+2TA)+TA	TH+3TA+CL
TH+(n-1)TA	TH+(n-1)TA+CL

TH: Text home address

TA: Text area number (columns)

CL: Columns are fixed by hardware (pin-programmable).

(Example)

Text home address : 0000H
Text area : 0020H

: 32 Columns

: 4 Lines

0000Н	0001H	001EH	001FH
0020Н	0021H	003EH	002FH
0040H	0041H	005EH	005FH
0060Н	0061H	007EH	007FH

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(2)Set Graphic Home Address

The starting address of the external display RAM used for graphic display is defined by this command.

The graphic home address indicates the leftmost and uppermost position.

The relationship between external display RAM address and display position

GH	GH+GL
GH+GA	GH+GA+CL
(GH+GA)+GA	GH+2GA+CL
(GH+2GA)+GA	GH+3GA+CL
GH+(n-1)GA	GH+(n-1)GA+CL

GH: Graphic home address

GA: Graphic area number (columns)

CL: Columns are fixed by hardware (pin-programmable).

(Example)

Graphic home address : 0000H

Graphic area : 0020H

: 32 Columns

: 2 Lines



0000Н	0001Н	001EH	001FH
0020H	0021H	003EH	003FH
0040H	0041H	005EH	005FH
0060Н	0061H	007EH	007FH
0080Н	0081H	009EH	009FH
00A0H	00A1H	00BEH	00BFH
00C0H	00C1H	00DEH	00DFH
00E0H	00E1H	00FEH	00FFH
0100H	0101H	011EH	011FH
0120H	0121H	013EH	013FH
0140H	0141H	015EH	014FH
0160H	0161H	017EH	017FH
0180H	0181H	109EH	019FH
01A0H	01A1H	01BEH	01BFH
01C0H	01C1H	01DEH	01DFH
01E0H	01E1H	01FEH	01FFH

(3)Set Text Area

The display columns are defined by the hardware Setting. This command can be used to adjust the columns of the display.

(Example)

LCD size 20 columns, 4lines

Text home address 0000H

Text area 0014H

Set 32 columns, 4 Lines

0000	0001	 0013	0014	 001F
0014	0015	 0027	0028	 0033
0028	0029	 003B	003C	 0047

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(4)Set Graphic Area

The display columns are defined by the hardware setting. This command can be used to adjust the columns of the graphic display.

(Example)

LCD size 20 columns, 2lines

Graphic home address : 0000H

Graphic are : 0014H

Set 32 columns, 2 Lines

0000	0001	 0013	0014	 001F
0014	0015	 0027	0028	 0033
0028	0029	 003B	003C	 0047
003C	003D	 004F	0050	 005B
0050	0051	 0063	0064	 006F
0064	0065	 0077	0078	 0083
0078	0079	 008B	008C	 0097
008C	008D	 009F	00A0	 00AB
00A0	00A1	 00B3	00B4	 00BF
00B4	00B5	 00C7	00C8	 00D3
00C8	00C9	 00DB	00DC	 00E7
00DC	00DD	 00EF	00F0	 00FD
00F0	00F1	 0103	0104	 011F

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0104	0105	 0127	0128	 0123
0128	0129	 013B	0013C	 00147
013C	013D	 014F	0150	 015B

→ LCD∢	-	

If the graphic area setting is set to match the desired number of columns on the LCD, the addressing scheme will be automatically modified so that the start address of each line equals the end address of the previous line +1.



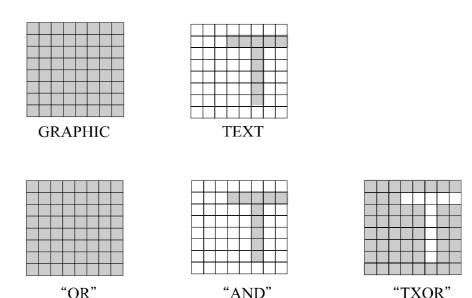
□ Mode set

CODE	FUNCTION	OPERAND
1000×000	OR Mode	-
1000×001	EXOR Mode	-
1000×011	AND Mode	-
1000×100	TEXT ATTRIBUTE Mode	-
10000×××	Internal Character Generator Mode	-
10001×××	External Character Generator Mode	-

X: invalid

The display mode is defined by this command. The display mode does not change until the next command is sent. The logical OR, EXOR, AND of text or graphic display can be displayed. In Internal Character Generator mode, character codes 00H to 7FH are assigned to the built-in character generator ROM. The character codes 80H to FFH are automatically assigned to the external character generator RAM.

(Example)



(Note)Attribute functions can only be applied to text display, since the attribute data is placed in the graphic RAM area

Attribute function

The attribute operations are Reverse display, Character blink and Inhibit. The attribute data is written into the graphic area which was defined by the Set Control Word command. Only text display is possible in Attribute Function mode; graphic display is automatically disabled. However, the Display Mode command must be used to turn both Text and Graphic on in order for the Attribute function to be available.

The attribute data for each character in the text area is written to the same address in the graphic area. The Attribute function is defined as follows.



Attribute RAM 1byte

×	×	×	×	d3	d2	d1	d0	
---	---	---	---	----	----	----	----	--

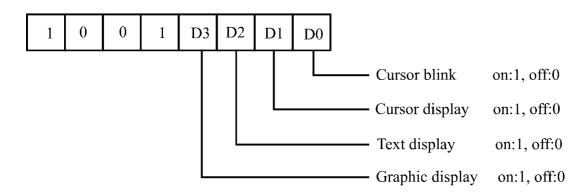
d3	d2	d1	d0	FUNCTION
0	0	0	0	Normal display
0	1	0	1	Reverse display
0	0	1	1	Inhibit display
1	0	0	0	Blink of normal display
1	1	0	1	Blink of reverse display
1	0	1	1	Blink of inhibit display

X: invalid

□Display mode

CODE	FUNCTION	OPERAND
10010000	Display off	-
1001××10	Cursor on, blink off	-
1001××11	Cursor on, blink on	-
100101××	Text on, graphic off	-
100110××	Text off, graphic on	-
100111××	Text on, graphic on	-

X: invalid



(Note)It is necessary to turn on "Text display" and "Graphic display" in the following cases.

a)Combination of text/graphic display

b)Attribute function

□Cursor pattern select

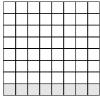
CODE	TV D LOTTLON	OPER LIVE
CODE	FUNCTION	OPERAND

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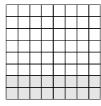


10100000	1-line cursor	-
10100001	2-line cursor	-
10100010	3-line cursor	-
10100011	4-line cursor	-
10100100	5-line cursor	-
10100101	6-line cursor	-
10100110	7-line cursor	-
10100111	8-line cursor	-

When cursor display is ON, this command selects the cursor pattern in the range 1 line to 8 lines. The cursor address is defined by the Cursor Pointer Set command.



1-line cursor



2-line cursor



8-line cursor

□ Data Auto Read/Write

CODE	HEX.	FUNCTION	OPERAND
10110000	ВОН	Set Data Auto Write	-
1011001	В1Н	Set Data Auto Read	-
10110010	В2Н	Auto Reset	-

The command is convenient for sending a full screen of data from the external display RAM. After setting Auto mode, a Data Write (or Read) command is need not be sent between each datum. A Data Auto Write (or Read) command must be sent after a Set Address Pointer command. After this command, the address pointer is automatically incremented by 1 after each datum. In Auto mode, the T6963C cannot accept any other commands.

The Auto Reset command must be sent to the T69963C after all data has been sent, to clear Auto mode.

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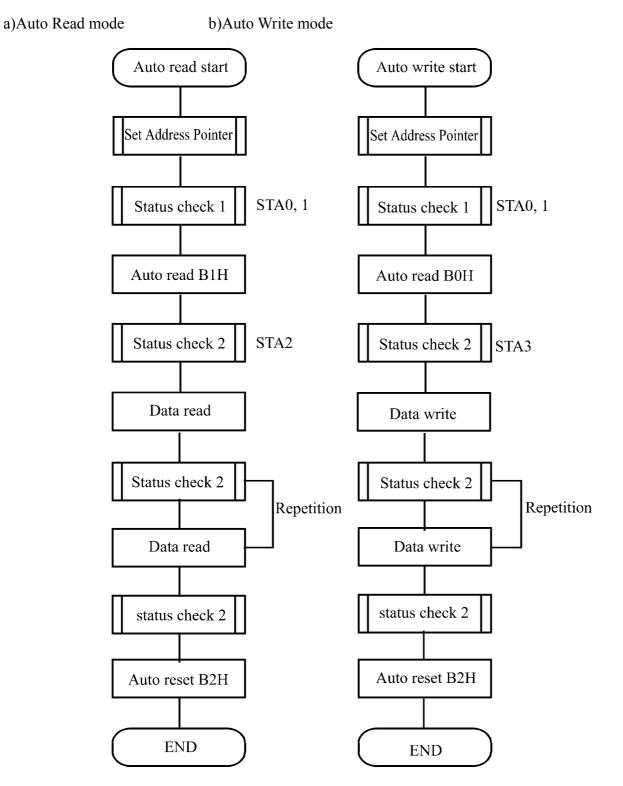


(Note)A Status check for Auto mode

(STA2, STA3 should be checked between sending of each datum. Auto Reset should be performed after checking STA3=1 (STA2=1.) Refer to the following flowchart.

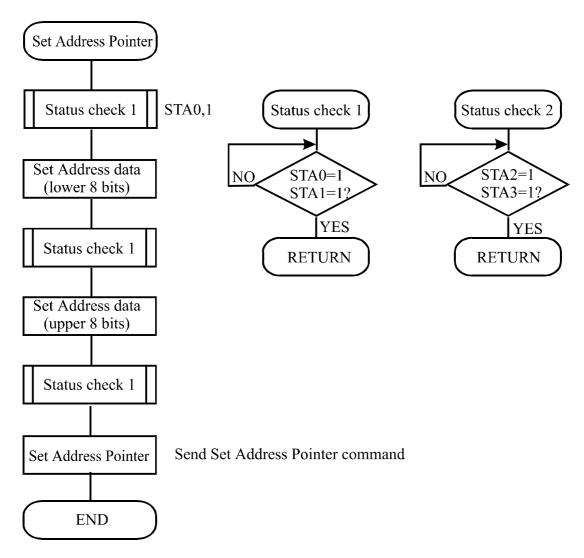
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□ Date Read/Write

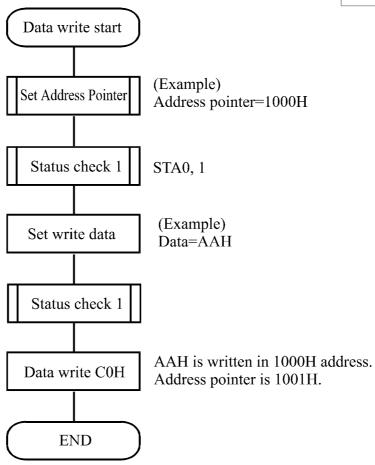
CODE	HEX.	FUNCTION	OPERAND
11000000	СОН	Data Write and Increment ADP	Data
11000001	C1H	Data Read and Increment ADP	-
11000010	С2Н	Data Write and Decrement ADP	Data
11000011	СЗН	Data Read and Decrement ADP	-
11000100	С4Н	Data Write and Non-variable ADP	Data
11000101	С5Н	Data Read and Non-variable ADP	-

This command is used for writing data from the MPU to external display RAM, and reading data from external display RAM to the MPU. Data Write/Data Read should be executed after setting address using Set Address Pointer command. The address pointer can be automatically incremented or decremented using this command.

(Note)This command is necessary for each 1-byte datum.

Refer to the following flowchart.





□Screen Peek

CODE	HEX.	FUNCTION	OPERAND
11100000	Е0Н	Screen Peek	- e

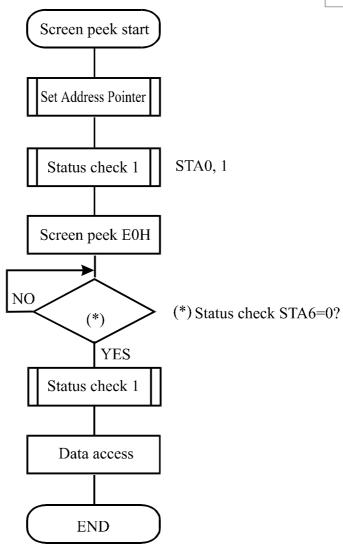
This command is used to transfer 1 byte of displayed data to the data stack; this byte can then be read from the MPU by data access. The logical combination of text and graphic display data on the LCD screen can be read by this command.

The status (STA6) should be checked just after the Screen Peek command. If the address determined by the Set Address Pointer command is not in the graphic area, this commands is ignored and a status flag (STA6) is set.

Refer to the following flowchart.

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□Screen Copy

CODE	HEX.	FUNCTION	OPERAND
11101000	E8H	Screen Copy	-

This command copies a single raster line of data to the graphic area.

The start point must be set using the Set Address Pointer command.

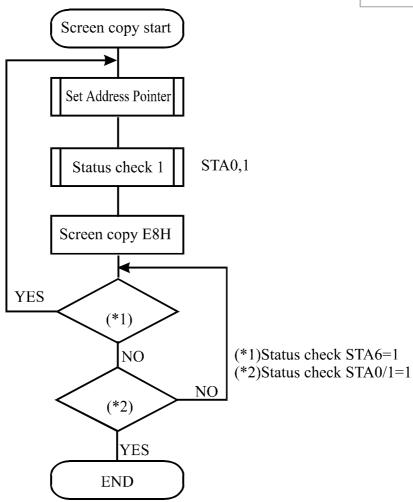
(Note 1) If the attribute function is being used, this command is not available.

(With Attribute data is graphic area data.)

Refer to the following flowchart.

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· Bit Set/Reset

CODE	FUNCTION	OPERAND
11110×××	Bit Reset	-
11111×××	Bit Set	-
1111×000	Bit 0 (LSB)	-
1111×001	Bit 1	-
1111×010	Bit 2	-

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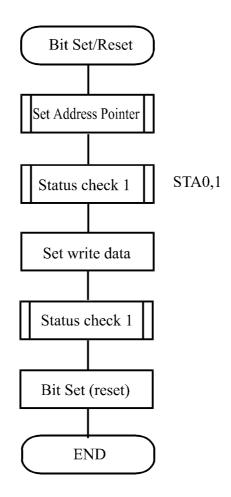
1111×011	Bit 3	-
1111×100	Bit 4	-
1111×101	Bit 5	-
1111×110	Bit 6	-
1111×111	Bit 7 (MSB)	-

X: invalid

This command use to set or reset a bit of the byte specified by the address pointer.

Only one bit can be set/reset at a time.

Refer to the following flowchart.



4.7 CHARACTER ROM MAP

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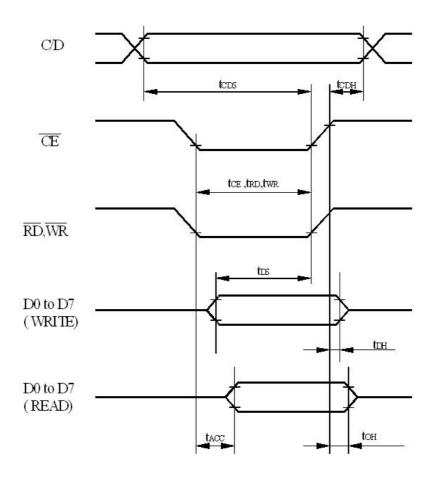
Unner	I							
Upper 4 bit								
Lower	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH
4 bit								
		===	_===_	====_	==		_====	_=
				==		====	1	
LLLL								
				_		_		
	_	_ =	_ = _	_===_				
		"[e" "e			_====		
LLLH	_	_ 🖺 _					= = =	
LLLII	-		-			-		
					_		_	
] =	=				
LLHL		_="	 	="="		= -		
LLHL			i===	=	i===-	=	_===	i i
			=	= " <i>-</i> =			===	
		=	1		=			
LLHH		-		-			=	
		.:	:		ļ	-		
	[: :[]				<u>-</u>		
LHLL	:		:	=	==	=		===
	_							
	== -			: :				. _
		= = = _	1			= =		
LHLH	- = = =	 =	!	==		 	-:::	==
	""							
	-			_			-	_
	≣ ¯ ≣	_ =	=			-		_ = - =
LHHL	│≘ <i>╹╼</i> ╻≣	= =		==			_====	
	===	_===-	=	_=-	■	-=-		
			=				_====	
	_	_=	i:				=	
LHHH		=						
	_ =		: :	: :	=		.".	
	≣			===			=	=≣
HLLL	_=_	= =						
		===			-			
	=	=		~ <i></i> _~~		: :		==
HLLH	_="	="						■ ■
	_			_				
-	_				_		-	
		11		│ _▃ ▝▝			==	= =
HLHL	[. :	- -	. :		i i	
1111111	_							_ === -
	=	==		=		===		[
111 1111						• -		
HLHH	_		= -	===	= "=			
		_ = =	1			I		_ = ⁼ =
		= =			=			
HHLL	• -						-1-	
			I:	:				
					<u></u>	= =		
HHLH						=		
			-					_
		=.	_ =	_ =		_ = .		
					=		_=_	=
HHHL	==	_ = "			!			
111111	==	•			-			
	_==				_===			_ # ^ =
		- "					<u> </u>	_"≣"
пппп	_				_			
нннн	_	=					==	
нннн	_	=					==	

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4.8 TIMING CHARACTERISTICS

Item	Symbol	Min	Тур	Max	Unit
C/D Set-up Time	tcds	100	-	-	ns
C/D Hold Time	tсdн	10	-	-	ns
CE,RD,WR Pulse Width	tcds,trd,twr	80	-	-	ns
Data Set-up Time	tos	80	-	-	ns
Data Hold Time	tdн	40	-	-	ns
Access Time	tacc	-	-	150	ns
Output Hold Time	tон	10	-	50	ns



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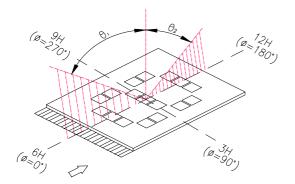


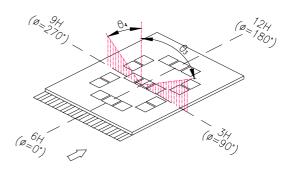
5 OPTICAL SPECIFICATION

 $Ta = 25 \, ^{\circ}C$

Item	Symbol	Condition	Min	Тур	Max	Unit	Note Note
	θ1	CR≥2	-	40	-	deg	1
Viewing Angle in	θ2	CR≥2	-	20	-	deg	1
STN	θ3	CR≥2	-	30	-	deg	2
	θ4	CR≥2	-	30	-	deg	2
Viewing Angle in FSTN	θ1	CR≥2	-	60	-	deg	1
	θ2	CR≥2	-	30	-	deg	1
	θ3	CR≥2	-	45	-	deg	2
	θ4	CR≥2	-	45	-	deg	2
Contrast Ratio	CR	Ta = 25 °C	-	5	-	-	3
р ті	Tr	Ta = 25 °C	-	200	300		4
Response Time	Tf	Ta = 25 °C - 150 250 ms				ms	4
Driving Method	Duty	1/128					
Viewing Direction	6 O'CLOCK						

Note 1: definition of viewing angle $\theta 1 \& \theta 2$ Note 2: definition of viewing angle $\theta 3 \& \theta 4$

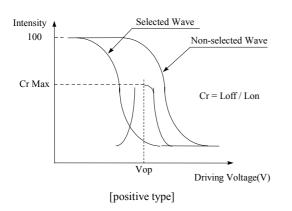


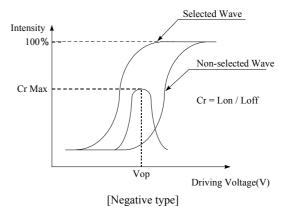


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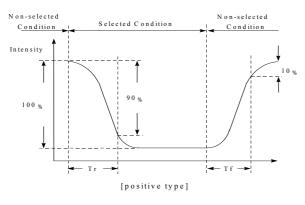


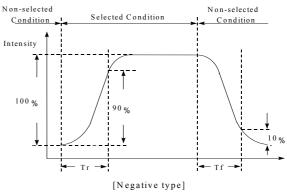
Note 3: definition of contrast ratio (CR)





Note 4: definition of response time





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6 TOUCH SCREEN SPECIFICATION

6.1 TOUCH SCREEN ELECTRICAL CHARACTERISTICS

Item	Specification	Condition	
ON Resistance	250 to 750 ohms	X Axis	
ON Resistance	250 to 800 ohms	Y Axis	
Insulation Resistance	More than 20Mohms	DC 25V	
Chattering Time	Less than 10ms	100Kohms Pull-Up	
Linconito	+/- 1,0%	X Axis	
Linearity	+/- 1,0%	Y Axis	

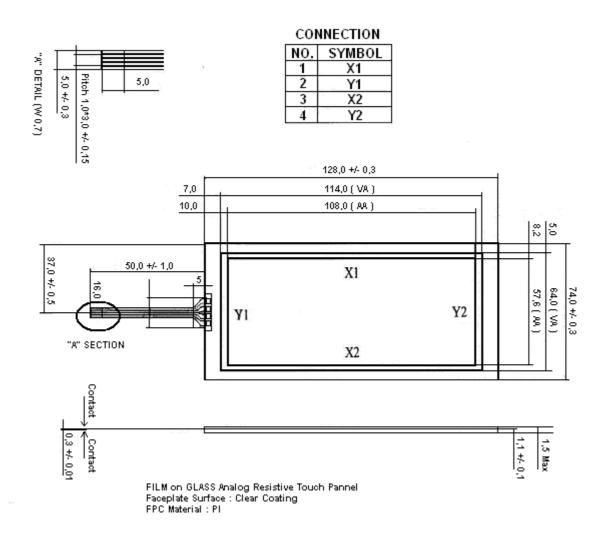
6.2 TOUCH SCREEN MECHANICAL CHARACTERISTICS

Item	Specification	Condition
Operating Force	Less than 80g	R8.0 HS 40 ° Silicon Rubber Or R0.8 Polyacetal Pen
Surface Hardness	More than 2H	Pencil Test
Light Transmission	More than 80%	@ 550 nm HITACHI U3300
Durability for Pen Selection	More than 1 200 000 times	Force : 250g Speed : 2cm / s

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6.3 TOUCH SCREEN MECHANICAL DRAWING



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7 BACKLIGHT SPECIFICATION

7.1 LED BACKLIGHT CHARACTERISTICS

7.1.1 WHITE EDGE LED BACKLIGHT CHARACTERISTICS

STANDARD

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Current	I	V = 3,5V	-	180	-	mA
Forward Voltage	V_{F}	$I_F = 180 \text{mA}$	-	3,5	-	V
Reverse Voltage	V_R		-	-	8	V
Luminous Intensity before through LCD	I_{V}	$I_F = 180 \text{mA}$	-	180	-	cd/m²
Life time		$I_F = 180 \text{mA}$	-	50K	-	hrs
Colour	WHITE					

HI-BRIGHTNESS

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Current	I	V = 3,5V	162	180	225	mA
Forward Voltage	V_{F}	$I_F = 180 \text{mA}$	3,4	3,5	3,6	V
Reverse Voltage	V_R		-	-	8	V
Luminous Intensity before through LCD	I_{V}	$I_F = 180 \text{mA}$	304	380	-	cd/m²
Life time		$I_F = 180 \text{mA}$	-	50K	-	hrs
Colour	WHITE					

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7.1.2 YELLOW GREEN STANDARD LED BACKLIGHT CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Current	I	V = 4.2V	-	900	1800	mA
Forward Voltage	V_{F}	$I_F = 900 \text{mA}$	-	4,2	4,6	V
Reverse Voltage	V_R		-	-	8	V
Luminous Intensity	I_{V}	$I_F = 900 \text{mA}$	160	200	-	cd/m²
LED Peak Emission Wavelength	λр	$I_F = 900 \text{mA}$	_	570	-	nm
Life time		$V_F \le 4.6V$	-	100K	-	hrs
Colour	YELLOW GREEN					

7.1.3 YELLOW GREEN EDGE LED BACKLIGHT CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Current	I	V = 4.2V	-	200	400	mA
Forward Voltage	V_{F}	$I_F = 200 \text{mA}$	_	4,2	4,6	V
Reverse Voltage	V_R		_	-	8	V
Luminous Intensity	I_{V}	$I_F = 200 \text{mA}$	80	100	-	cd/m²
LED Peak Emission Wavelength	λр	$I_F = 200 \text{mA}$	-	570	-	nm
Life time		$I_F = 200 \text{mA}$	-	100K	-	hrs
Colour	YELLOW GREEN					

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7.2 CCFL BACKLIGHT CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage	V	I = 5mA	230	250	270	V
Starting Voltage	Vs	25°C 0°C	-	-	590 650	V
Supply Current	I		4,5	5,0	5,5	mA
Lamp Power	P	I x V	-	1,03	-	Wrms
Luminous Intensity	I_{V}	I = 5mA	250	-	-	cd/m²
Chromaticity	(X) (Y)		0,307 0,329	0,308 0,330	0,309 0,331	
Life time		$I_F = 5mA$	-	20K	-	hrs
Colour	WHITE					



8 QUALITY ASSURANCE SPECIFICATION

8.1 CONFORMITY

The performance, function and reliability of the shipped products conform to the Product Specification.

8.2 DELIVERY ASSURANCE

8.2.1 Delivery inspection standards.

- MIL-STD-105E, general inspection level II, single sampling level;
- IPC-AA610 rev. C, class 2 electronic assemblies standard

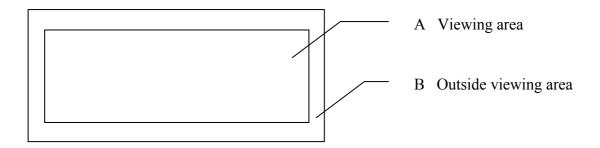
The quality assurance levels are shown below:

Rank	Item Inspected	Defect type	AQL	Remark	
		Non display			
		Over current		Dismlary	
	Display	Missing segment	0.65%	Display malfunction	
Critical defect		Wrong viewing direction			
		Backlight OFF			
	Dimension	PCB and bezel out of	0.65%	Assembly	
	Difficusion	specification	0.0376	failure	
	Display	Incorrect operating			
Major defect	Backlight	Flashing, dust	1.0%		
	Dacklight	Wrong colour			
		Black and white spot			
		Black and white lines			
		Polariser scratch			
	LCD	Bubbles in polariser			
		Segment deformation, pin hole			
		Colour uniformity			
Minor defect		Glass chip	2.5%	Appearance defect	
		Wire bond pad exposed		defect	
	COB	Insufficient covering with			
	resin (wire bond line exposed)				
		Bubble, dust on COB			
	PCB Dust, solder ball on PCB]		
	rCD	Pad scratch			
		Total	2.5%		

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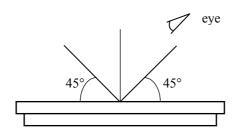


8.2.2 Zone definition



8.2.3 Visual inspection

- Inspect under 2x20W or 40W fluorescent lamp (approximately 3000 lux) leaving 25 to 30 cm between the module and the lamp and 30 cm between the module and the eye (measuring position).
- Appearance is inspected at the best contrast voltage (best contrast is adjusted considering clearness and crosstalk on screen).
- Inspect the module at 45° right and left, top and bottom.
- Use the optimum viewing angle during the contrast inspection.





8.2.4 Standard of appearance inspection

Units: mm

	115. 111111						
No	Item	Criteria					
1	Black spot,	Round type: as per following drawing					
	white spot, dust	$\varnothing = (X+Y)/2$					
		Acceptable quantity					
			Size	Zone A	Zone B		
		\	Ø<0.1	Any number			
		Y	0.1<Ø<0.2	6	Any number		
		→ - 	0.2<Ø<0.3	2	Any number		
		X	0.3<Ø	0			
		Line type: as per following	no drawino				
		Eme type: as per following		ole quantity			
		W Length	Width	Zone A	Zone B		
			W≤0.02	Any number			
		L≤3.0	0.02 <w≤0.03< td=""><td></td><td>A</td></w≤0.03<>		A		
		L≤2.5	0.03 <w≤0.05< td=""><td>2</td><td>Any number</td></w≤0.05<>	2	Any number		
		L	0.05 <w< td=""><td>As round type</td><td></td></w<>	As round type			
2	Polariser scratch	Scratch on protective film Scratch on polariser: sam					
3	Polariser bubble	$\varnothing = (X+Y)/2$					
			A	cceptable quantity	7		
			Size	Zone A	Zone B		
		+	Ø<0.3	Any number			
		Y	0.3<Ø<1.0	3	Any number		
		→ **	1.0<Ø<1.5	1	Any number		
		X	1.5<Ø	0			
			Total acceptable	quantity: 4			
4	Segment	1.a. Pin hole on segmente	ed display				
	deformation	***					
		W: segment width					
		$\varnothing = (A+B)/2$		cceptable quantity			
		B	Width W≤0.4	Ø<0.2 and			
			W≥0.4 W>0.4	$\emptyset \leq 0.2$ and			
		<i> </i>		$\varnothing \leq 0.25$ and quantity: 1 defect			
				g quantity. T defect of under 0.10 mm a	. •		
			1 in noies with x	under 0.10 milli 8	ire acceptable		
		I					

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No	Item	Criteri	0		
110	Item				
4	Segment	1b. Pin hole on dot matrix display			
	deformation	W <0.05 , , ,	Acceptable	quantity	
			Size	A	
		(d) d	a,b < 0.1 $(a+b)/2 \le 0.1$	Any number Any number	
			$0.5 < \emptyset < 1.0$	3	
			Total acceptable		
		2. Segments / dots with different width			
			Accep		
			a≥b	a/b≤4/3	
			a <b< td=""><td>a/b>4/3</td></b<>	a/b>4/3	
	Colors	3. Alignment layer defect $\emptyset = (a+b)/2$	Acceptable Size $\emptyset \le 0.4$ $0.4 < \emptyset \le 1.0$ $1.0 < \emptyset \le 1.5$ $1.5 < \emptyset \le 2.0$ Total acceptable	Any number 5 3 2	
5	Colour uniformity	Level of sample for approval set as limit sa	ample		
6	Backlight	The backlight colour should correspond to Flashing and or unlit backlight is not allow Dust larger than 0.25 mm is not allowed		ication	
7	COB	Exposed wire bond pad is not allowed Insufficient covering with resin is not allowed Dust or bubble on the resin are not allowed		e exposed)	
8	PCB	No unmelted solder paste should be present Cold solder joints, missing solder connecting No residue or solder balls on PCB are allow Short circuits on components are not allow	ons, or oxidation a wed	re not allowed	

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9 RELIABILITY SPECIFICATION

Test Item	Test Condition	Description
High Temperature Operation	50°C or 70°C 200hrs	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.
Low Temperature Operation	0°C or -20°C 200hrs	Endurance test applying the electric stress under low temperature for a long time.
High Temperature Storage	70°C or 80°C 200hrs	Endurance test applying the high storage temperature for a long time.
Low Temperature Storage	-20°C or -30°C 200hrs	Endurance test applying the high storage temperature for a long time.
High Temperature & High Humidity Storage	80°C,90%RH 96hrs	Endurance test applying the high temperature and high humidity storage for a long time.
Thermal Shock Test	30°C 25°C 80°C 30min 5min 30min For 10 cycles	Endurance test applying the low and high temperature cycle. Burn In Test.
Vibration	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hrs	Endurance test applying the vibration during transportation and using.
ESD	VS=800V,RS=1.5kΩ CS=100pF	Endurance test applying the electric stress to the terminal.
Shock Test	50G Half sign wave 11 msec 3 times of each direction	Constructional and mechanical endurance test applying the shock during transportation.

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10 HANDLING PRECAUTIONS

Safety

If the LCD panel breaks, be careful not to get the liquid crystal fluid in your mouth or in your eyes. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and plenty of water.

Mounting and Design

Place a transparent plate (e.g. acrylic, polycarbonate or glass) on the display surface to protect the display from external pressure. Leave a small gap between the transparent plate and the display surface.

When assembling with a zebra connector, clean the surface of the pads with alcohol and keep the surrounding air very clean.

Design the system so that no input signal is given unless the power supply voltage is applied.

Caution during LCD cleaning

Lightly wipe the display surface with a soft cloth soaked with Isopropyl alcohol, Ethyl alcohol or Trichlorotriflorothane.

Do not wipe the display surface with dry or hard materials that will damage the polariser surface.

Do not use aromatic solvents (toluene and xylene), or ketonic solvents (ketone and acetone).

Caution against static charge

As the display uses C-MOS LSI drivers, connect any unused input terminal to VDD or VSS. Do not input any signals before power is turned on.

Also, ground your body, work/assembly table and assembly equipment to protect against static electricity.

Packaging

Displays use LCD elements, and must be treated as such. Avoid strong shock and drop from a height. To prevent displays from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity.

Caution during operation

It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life. Direct current causes an electrochemical reaction with remarkable deterioration of the display quality. Give careful consideration to prevent direct current during ON/OFF timing and during operation.

Response time is extremely delayed at temperatures lower than the operating temperature range while, at high temperatures, displays become dark. However, this phenomenon is reversible and does not mean a malfunction or a display that has been permanently damaged.

If the display area is pushed on hard during operation, some graphics will be abnormally displayed but returns to a normal condition after turning off the display once.

Even a small amount of condensation on the contact pads (terminals) can cause an electro-chemical reaction which causes missing rows and columns. Give careful attention to avoid condensation.

Storage

Store the display in a dark place where the temperature is $25^{\circ}\text{C} \pm 10^{\circ}\text{C}$ and the humidity below 50%RH.

Store the display in a clean environment, free from dust, organic solvents and corrosive gases.

Do not crash, shake or jolt the display (including accessories).

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